

Electronic Goods Packaging Market is Expected to Grow at a CAGR of 5% by 2023

Global Electronic Goods Packaging Market Information Report By Material, By Product Size, By Technology and By Region - Forecast to 2023

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Key Players: DS Smith Plc.,
International Paper
Company, Mondi plc.,
Sealed Air Corporation "
Market Research Future

published a half cooked research report on Global [Electronic goods packaging market](#). The Electronic goods packaging market is expected to grow over the CAGR of around 5 % during the period 2017 to 2023.

Market Highlights:

The electronic goods packaging market is majorly driven by the increased need of packaging the electronic products basically for preventing them from the external damages.

The boom in the e-commerce industry especially for electronic goods is also driving the growth of the electronic goods packaging market. The increase in internet based shopping and the app based shopping is also contributing to the growth of the electronic goods packaging market. However, the increase in the pressure for prices of the products is hindering the growth of the market.

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Key Players of Electronic Goods Packaging Market:

- DS Smith Plc. (U.K.)
- International Paper Company (U.S.)
- Mondi plc. (Austria)
- Sealed Air Corporation (U.S.)
- Smurfit Kappa (Republic of Ireland)
- Dunapack Packaging (Austria)
- Georgia-Pacific LLC (U.S.)
- Graham Packaging (U.S.)
- Bregis LLC (U.S.)
- Sonoco Products Company (U.S.)
- Stora Enso (Finland)

Market Research Analysis:

The Asia-Pacific region is expected to grow the highest in the Electronic goods packaging market owing to the availability of low cost labor in the region. The rapid advancements in the industrial sector of the region is leading to an increased production of all kinds of electronic goods, thereby leading to an increase in demand for electronic goods packaging market. The large scope of FDI in the emerging economies of the region such as India and China is also contributing to the growth of the electronics industry thereby driving the need of the electronics goods packaging industry.

Scope of the Report:

This study provides an overview of the global Electronic goods packaging market, tracking three market segments across four geographic regions. The report studies key players, providing a

five-year annual trend analysis that highlights market size, volume and share for North America, Europe, Asia Pacific (APAC) and Rest of the World (ROW). The report also provides a forecast, focusing on the market opportunities for the next five years for each region. The scope of the study segments the global Electronic goods packaging market by its material, product size, technology and region.

By Material

- Corrugated boxes
- Foamed plastic
- Paperboard
- Bubble packaging
- Others

By product size

- Small appliances
- Large appliances

By Technology

- Authentication packaging
- Track and trace packaging

By Region

- North America
- Asia Pacific
- Europe
- Rest of the World

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In order to stay updated with technology and work process of the industry, MRFR often plans & conducts meet with the industry experts and industrial visits for its research analyst members.

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